

2815
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Noriaki Sakamoto et al.

Serial No. : 09/821,361

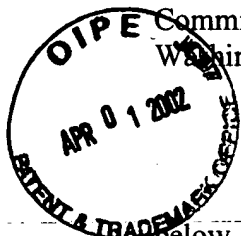
Filed : March 29, 2001

Title : SEMICONDUCTOR DEVICE AND METHOD OF MANUFACTURING THE SAME

Art Unit : 2815

Examiner : Chris C. Chu

COPY OF PAPERS
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Commissioner for Patents
Washington, D.C. 20231

TRANSMITTAL LETTER

Correspondence relating to this application is enclosed. The required fees are computed below. Please apply any charges not covered, or any credits, to Deposit Account No. 06-1050.

Total Claims	27	-	21	=	6	\$108
Independent	8	-	6	=	2	\$168
First Presentation of Multiple Dependent Claims						\$0
TOTAL FEE DUE						\$276

A check for \$276 is attached.

Respectfully submitted,

Date: March 21, 2002

John B. Pegram
John B. Pegram
Reg. No. 25,198

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TECHNOLOGY CENTER 2800

Fish & Richardson P.C.
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New York, New York 10111
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CERTIFICATE OF MAILING BY FIRST CLASS MAIL

I hereby certify under 37 CFR §1.8(a) that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage on the date indicated below and is addressed to the Commissioner for Patents, Washington, D.C. 20231.

MARCH 21, 2002

Date of Deposit

Signature

PATRICIA F. SUCHANEK

Typed or Printed Name of Person Signing Certificate



Attorney's Docket No.: 10417-074001 / F51-429328M/SMI

#6 / Amended
4/24-02
J.D.

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AMENDMENT

In response to the action mailed December 21, 2001, please amend the application as follows:

In the specification:

Please replace the specification with the substitute specification provided herein.

In the claims:

Claims 22-27 have been added.

Claims 1-3, 5-9, and 11-12 have been cancelled.

Claims 4 and 10 have been amended.

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4. (Amended) A semiconductor device comprising:

a first and a second semiconductor chip which are electrically connected to each

other;

a first die pad to which said first semiconductor chip is fixed;

a second die pad to which said second semiconductor chip is fixed;

AI
cont

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04/03/2002 NMOHAMM1 00000067 09821361

01 FC:103
02 FC:102

108.00 OP
168.00 OP

MARCH 21, 2002

Date of Deposit

Patricia F. Suchanek
Signature

PATRICIA F. SUCHANEK
Typed or Printed Name of Person Signing Certificate